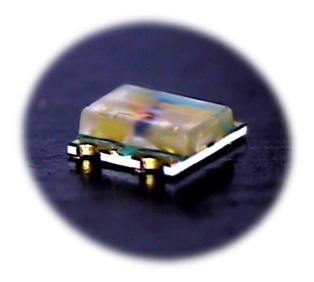


Harvatek Surface Mount CHIP LED Data Sheet E3823RGB-10D-000114



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DISCLAIMER

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Life Support Policy

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

	Specification	Material	Quantity
Luminous	R : Max:120mcd;min:80 mcd		
Intensity(Iv)	G : Max:450 mcd;min:310 mcd		
	B : Max:120mcd;min:80 mcd		
	R/G/B@10mA/ Ts= 25° C;Tolerance ±10%		
WD	R : Max:635nm;min:615nm		
	G : Max:535nm;min:515nm		
	B : Max:479nm;min:469nm		
	R/G/B@10mA/ Ts= 25° C;Tolerance ± 0.5nm		
Vf	R : Max:2.40V;min:1.60V		
	G : Max:3.30V;min:2.50V		
	B : Max:3.30V;min:2.50V		
	R/G/B@10mA/ Ts= 25° C;Tolerance ± 0.05V		
Ir/Vr	R:0~1uA@ V _R =5V		
	B/G: >500uA @ V _R =0.8V		
Vfp	R:>1.35V@1uA		
	G:>1.9V@1uA		
	B:>1.9V@1uA		
	R/G/B@10mA/ Ts= 25° C;Tolerance ± 0.05V		
Resin	Diffused	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	4000pcs/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

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Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, CIE and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

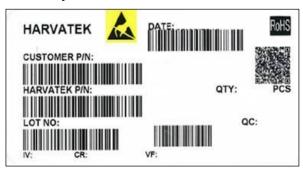


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

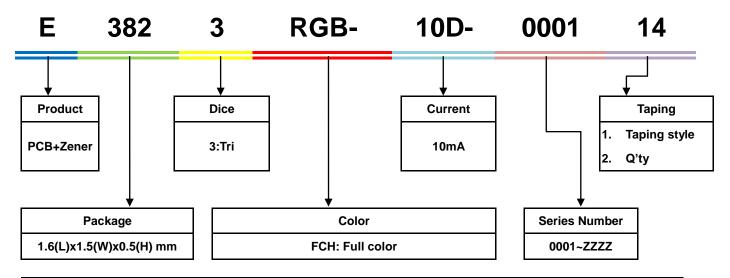
be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Specifications



Harvatek P/N:



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Lot No.:

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	
Internal Tracing Code	2010-A 2011-B 2012-C 2013-D	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	~ZZ		000~ZZZ	

Bin code

■ Luminous Intensity (Iv)

HT-E3823RGB @10 mA bin code								
IV								
Red Green						Blue		
FA1	80	120	FB1 310 450 FA1 80				120	

Note: It maintains a tolerance of ±10% on IV

■ Dominant Wavelength (λ_D)

HT-E3823RGB @10 mA bin code									
WD									
Red				Green			Blue		
R1	615	635	G1 515 535			B1	469	474	
	B2 474 479								

Note: It maintains a tolerance of ±0.5nm on WD

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■ Forward Voltage (Vf)

HT-E3823RGB @10 mA bin code										
Vf										
Red Green Blue										
E18	1.6	2.4	G7	2.5	2.7	G7	2.5	2.7		
-			G8	2.7	2.9	G8	2.7	2.9		
-			H7	2.9	3.1	H7	2.9	3.1		
-			H8	3.1	3.3	H8	3.1	3.3		

Note: It maintains a tolerance of ±0.05V on Vf

Product Features

Electro-Optical Characteristics

(I_F Red & Green &Blue@10mA, T_a 25 °C)

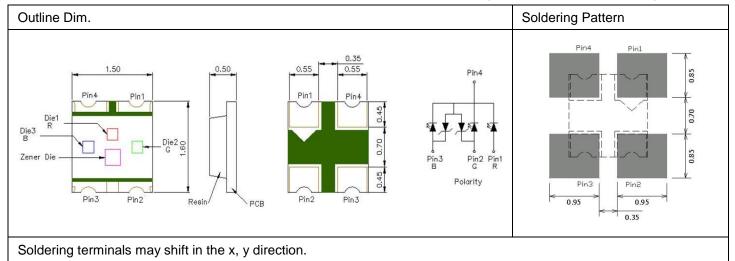
Part number	Emitting Forward umber Color Voltage			Wavelength (nm) typ.			I [*] _V (mcd)		IF(mA)	Viewing Angle 2 0 1/2
		typ.	max.	λD	λр	Δλ	min.	typ.		Aligie 201/2
	Ultra Bright Red	1.9	2.4	620	628	14	80	120		
E3823RGB-10	Green	2.9	3.3	530	520	32	310	450	10	120
	Blue	2.9	3.3	470	465	20	80	120		

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Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit: mm Tolerance: +/-0.05)



Absolute Maximum Ratings

(T_{Soldering} 25 °C)

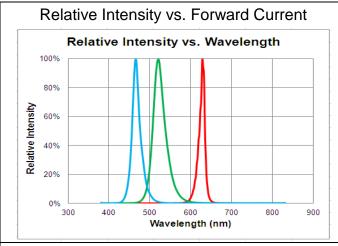
Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (°C)	
Color	Power Dissipation	Forward	Pulse Forward Current	Operating	Storage Temperature	
Coloi	T Ower Dissipation	Current		Temperature	Storage remperature	
Red	30	10	30	-40~+85	-40~+100	
Blue/Green	35	10	30	-40~+60	-40~+100	

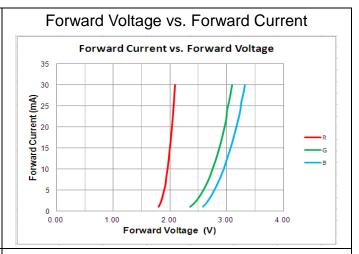
^{*} Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

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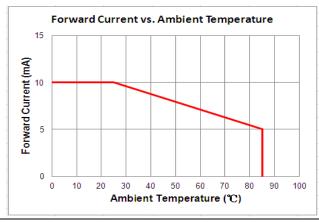


Characteristics of E3823RGB

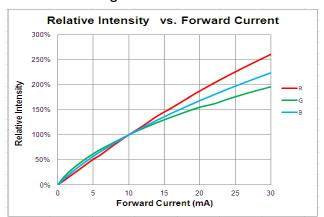




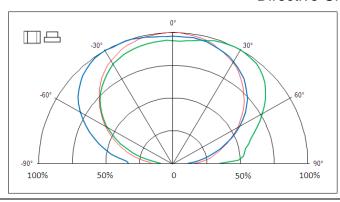


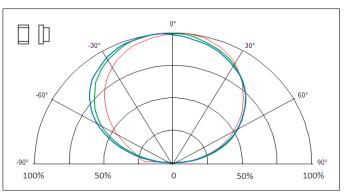






Directive Characteristics





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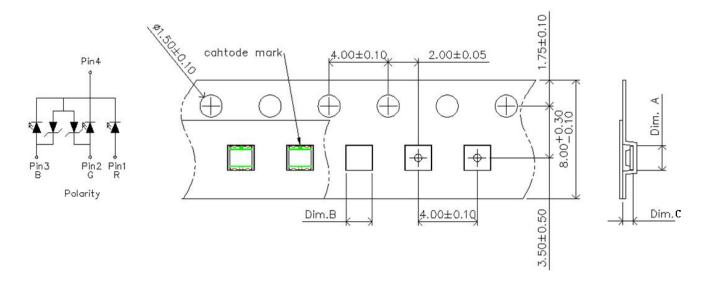
Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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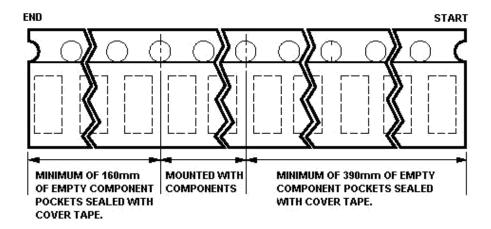


Packaging Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.65±0.05	1.75±0.05	0.70±0.05	4K

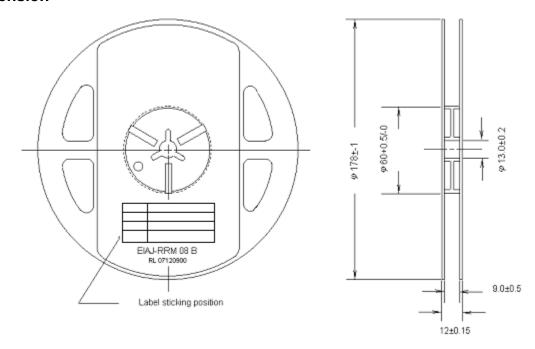
Unit: mm



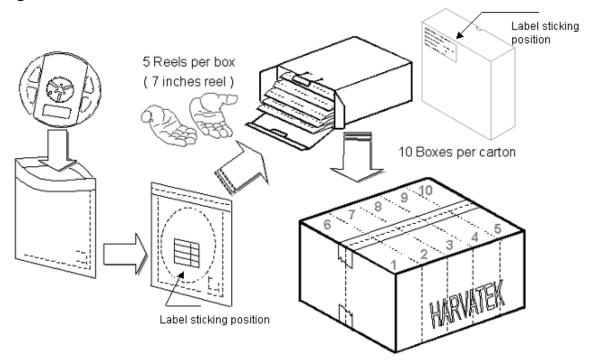
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Reel Dimension



Packing



5 boxes per carton is available depending on shipment quantity.

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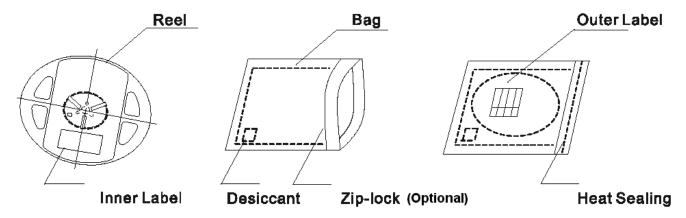


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1. $60\pm3^{\circ}$ C ×(12~24hrs)and<5%RH, taped reel type.
- 2. 100±3°C x(45min~1hr), bulk type.
- 3. $130\pm3^{\circ}$ C×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

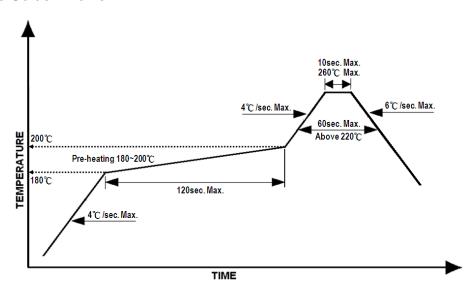
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Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220 ^OC ,60 sec.
- 2. Peak temp.:260 ^OCMax.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:
- 6. Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
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